

BUL128D-B

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- n STMicroelectronics PREFERRED SALES TYPE
- n NPN TRANSISTOR
- n HIGH VOLTAGE CAPABILITY
- n LOW SPREAD OF DYNAMIC PARAMETERS
- n MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- n VERY HIGH SWITCHING SPEED
- n INTEGRATED ANTIPARALLEL COLLECTOR- EMITTER DIODE

APPLICATIONS

- ELECTRONIC BALLAST FOR FLUORESCENT LIGHTING
- n FLYBACK AND FORWARD SINGLE TRANSISTOR LOW POWER CONVERTERS



The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The device is designed for use in lighting applications and low cost switch-mode power supplies.

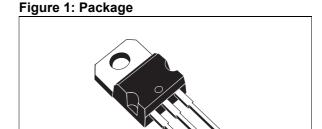


Figure 2: Internal Schematic Diagram

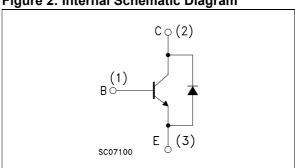


Table 1: Order Codes

Part Number	Marking	Package	Packaging
BUL128D-B	BUL128D-B	TO-220	Tube

Table 2: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-Emitter Voltage (V _{BE} = 0)	700	V	
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V	
V _{EBO}	Emitter-Base Voltage	V _{(BR)EBO}	V	
	$(I_C = 0, I_B = 2 A, t_p < 10 \mu s, T_J = 150 {}^{\circ}C)$			
I _C	Collector Current	4	Α	
I _{CM}	Collector Peak Current (t _p < 5ms)	8	Α	
I _B	Base Current	2	Α	
I _{BM}	Base Peak Current (t _p < 5ms)	4	Α	

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Symbol	Parameter	Value	Unit
P _{tot}	Total Dissipation at T _C = 25 °C	70	W
T _{stg}	Storage Temperature	-65 to 150	°C
T _J	Max. Operating Junction Temperature	150	°C

Table 3: Thermal Data

R _{thj-case}	Thermal Resistance Junction-Case	Max	1.78	°C/W
R _{thj-amb}	Thermal Resistance Junction-Ambient	Max	62.5	°C/W

Table 4: Electrical Characteristics (T_{case} = 25 °C unless otherwise specified)

Symbol Parameter		Test Conditions		Min.	Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current	V _{CE} = 700 V				100	μA
	(V _{BE} = 0 V)	V _{CE} =700 V	T _j = 125 °C			500	μA
I _{CEO}	Collector Cut-off Current	V _{CE} = 400 V	•			250	μΑ
	(I _B = 0)						
$V_{(BR)EBO}$	Emitter-Base Breakdown Voltage	I _E = 10 mA		9		18	V
	$(I_C = 0)$						
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage	I _C = 100 mA	L = 25 mH	400			V
	$(I_B = 0)$						
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 0.5 A	I _B = 0.1 A			0.7	V
		I _C = 1 A	$I_{B} = 0.2 A$			1	V
		I _C = 2.5 A	I _B = 0.5 A			1.5	V
		I _C = 4 A	I _B = 1 A		0.5		V
V _{BE(sat)} *	Base-Emitter Saturation	$I_C = 0.5 A$	I _B = 0.1 A			1.1	V
	Voltage	I _C = 1 A	$I_{B} = 0.2 A$			1.2	V
		I _C = 2.5 A	$I_{B} = 0.5 A$			1.3	V
h _{FE} *	DC Current Gain	I _C = 10 mA	V _{CE} = 5 V	10			
		I _C = 2 A	$V_{CE} = 5 V$	12		32	
	RESISTIVE LOAD	V _{CC} =200 V	I _C = 2 A				
t_s	Storage Time	I _{B1} = 0.4 A	$V_{BE(off)} = -5 V$		0.6		μs
t_f	Fall Time	$R_{BB} = 0 \Omega$	L = 200 µH		0.1		μs
		(see figure 15)					
	INDUCTIVE LOAD	V _{CC} =250 V	I _C = 2 A				
t_s	Storage Time	I _{B1} = 0.4 A	$I_{B2} = -0.4 \text{ A}$	2		2.9	μs
t _f	Fall Time	Tp = 30 µs	(see figure 14)		0.2		μs

^{*} Pulsed: Pulsed duration = 300 μ s, duty cycle \leq 1.5 %.

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Figure 3: Safe Operating Area

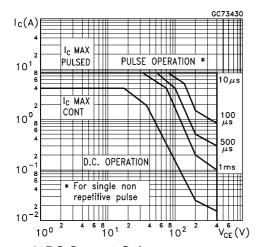


Figure 4: DC Current Gain

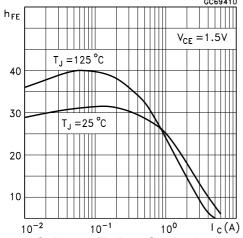


Figure 5: Collector-Emitter Saturation Voltage

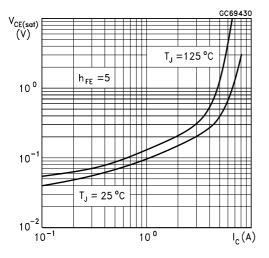


Figure 6: Derating Current

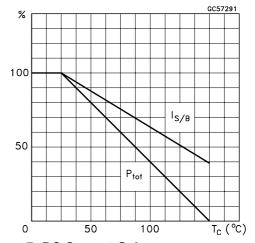


Figure 7: DC Current Gain

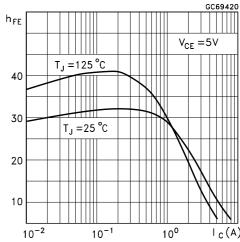


Figure 8: Base-Emitter Saturation Voltage

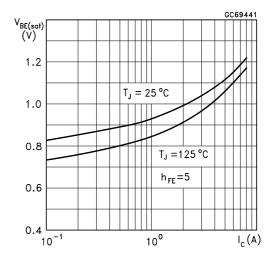


Figure 9: Inductive Load Fall Time

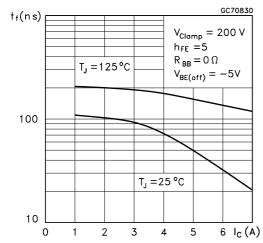


Figure 10: Resistive Load Fall Time

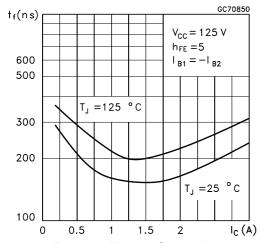


Figure 11: Reverse Biased Operating Area

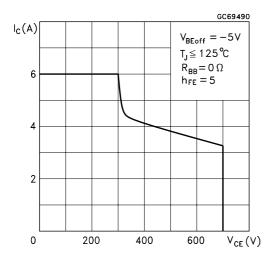


Figure 12: Inductive Load Stoarage Time

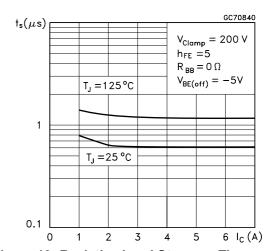
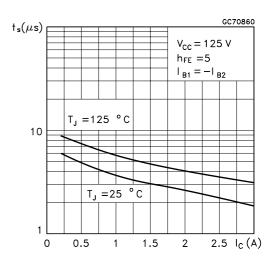


Figure 13: Resistive Load Stoarage Time



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Figure 14: Inductive Load Switching Test Circuit

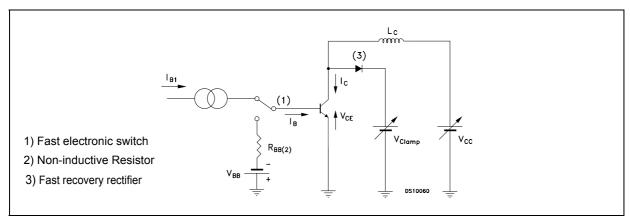
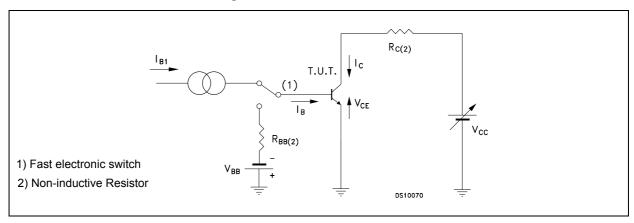
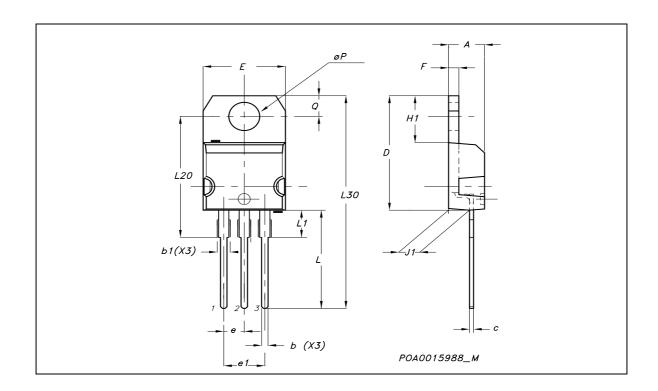


Table 15: Restistive Load Switching Test Circuit



TO-220 MECHANICAL DATA

DIM.		mm.			inch			
DIN.	MIN.	TYP	MAX.	MIN.	TYP.	MAX.		
А	4.40		4.60	0.173		0.181		
b	0.61		0.88	0.024		0.034		
b1	1.15		1.70	0.045		0.066		
С	0.49		0.70	0.019		0.027		
D	15.25		15.75	0.60		0.620		
E	10		10.40	0.393		0.409		
е	2.40		2.70	0.094		0.106		
e1	4.95		5.15	0.194		0.202		
F	1.23		1.32	0.048		0.052		
H1	6.20		6.60	0.244		0.256		
J1	2.40		2.72	0.094		0.107		
L	13		14	0.511		0.551		
L1	3.50		3.93	0.137		0.154		
L20		16.40			0.645			
L30		28.90			1.137			
øΡ	3.75		3.85	0.147		0.151		
Q	2.65		2.95	0.104		0.116		



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Table 5:

Version	Release Date	Change Designator
01-Oct-2002	1	First Release.
15-Feb-2005	1	Added table 1 on page 1.

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